

# Hardware Integration Guide SDC-MCF10AG

version 1.06

# **Revision History**

Version	Revision Date	Change Description
1.0		Transitioned Application Notes documentation to Hardware Integration Guide format.
1.01	01/04/10	Revised Operational Statement. Added Regulatory section.
1.02	03/03/10	Added RF Layout Guidelines section.
1.03	05/03/10	Edited Specifications table.
1.04	07/27/10	Revised Operational Description. Updated Pin table. Revised RF Layout Design Guidelines.
1.05	08/15/12	Updated Certifications.
1.06	01/31/13	Updated Channel and Frequency data.



# **Contents**

Scope	4
Operational Description	4
Block Diagram	5
Specifications	5
Recommended Operating Conditions	10
Pin Definitions	11
Mechanical Specifications	14
Connector Overview	14
Mounting	14
RF Layout Design Guidelines	14
Regulatory	15
Certified Antennas	15
Documentation Requirements	15
FCC	16
Industry Canada	17
European Union	19

## Scope

This document describes key hardware aspects of the Summit SDC-MCF10AG 802.11a/g embedded wireless LAN module. This document is intended to assist device manufacturers and related parties with the integration of this radio into their host devices. Data in this document is drawn from a number of

sources and includes information found in the Broadcom BCM4318E data sheet issued in July of 2006.

The information in this document is subject to change without notice. Please contact Summit or visit the Summit website at <a href="http://www.summitdata.com/">http://www.summitdata.com/</a> to obtain the most recent version of this document.

## **Operational Description**

This device is an SDC-MCF10AG 802.11a/g embedded wireless LAN module, which operates in unlicensed portions of the 2.4 GHz and 5 GHz radio frequency spectrum. The device is compliant with IEEE 802.11a, 802.11b, and 802.11g standards using Direct Sequence Spread Spectrum and Orthogonal Frequency Division Multiplexing. The device supports all 802.11a, 802.11b, and 802.11g data rates and automatically adjusts data rates and operational modes based on various environmental factors.

When operating on channels in the UNII-2 and UNII-2 Extended bands that are in the 5GHz portion of the frequency spectrum and are subject to



Dynamic Frequency Selection requirements, the SDC-MCF10AG fully conforms to applicable regulatory requirements. In the event that specified types of radar are detected by the network infrastructure, the SDC-MCF10AG will fully conform to commands from the infrastructure for radar avoidance.

The SDC-MCF10AG interfaces to host devices via a 60-pin connector. The device is based on the Broadcom BCM4318e chip which is an integrated device providing a Media Access Controller (MAC), a Physical Layer Controller (PHY or baseband processor) and a 2.4 GHz transceiver. The SDC-MCF10AG incorporates an external 5 GHz transceiver to allow for dual band operation. To maximize operational range, the SDC-MCF10AG incorporates 2.4 GHz and 5 GHz Power Amplifiers to increase transmit power to as much as 18 dBm (63 mW) and a 2.4 GHz Low Noise Amplifier to improve receiver sensitivity. The frequency stability for both 2.4 GHz (802.11b and 802.11g) and 5 GHz (802.11a) operation is +/- 20 ppm.

The SDC-MCF10AG has its own RF shielding and does not require shielding provided by the host device into which it is installed in order to maintain compliance with applicable regulatory standards. As such, the device may be tested in a standalone configuration via an extender card.

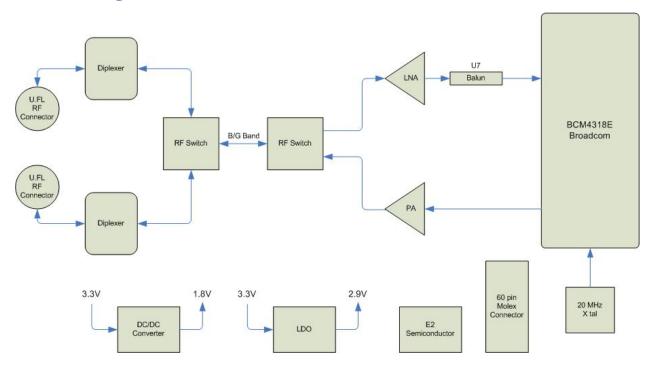
The device buffers all data inputs so that it will comply with all applicable regulations even in the presence of over-modulated input from the host device. Similarly, the SDC-MCF10AG incorporates power regulation to comply with all applicable regulations even when receiving excess power from the host device.

The SDC-MCF10AG provides two diplexed antenna connectors (Hirose U.FL type) to support dual band transmit and receive diversity. Supported host device antenna types include dipole and monopole antennas.



Regulatory operational requirements are included with this document and may be incorporated into the operating manual of any device into which the SDC-MCF10AG is installed. The SDC-MCF10AG is designed for installation into mobile devices such as vehicle mount data terminals which typically operate at distances greater than 20 cm from the human body and portable devices such as handheld data terminals which typically operate at distances less than 20 cm from the human body See "<u>Documentation Requirements</u>" for more information.

# **Block Diagram**



# **Specifications**

Feature	Description		
System Interface	16-bit Compact Flash with Molex 54722-0607 60-pin connector (mates to Molex connector 55560-0607)		
Antenna Interface	2 Hirose U.FL connectors for dual-band antenna diversity		
Chip Set	Broadcom BCM4318E		
Input Voltage Requirements	3.3 VDC +/- 10%		
Current Consumption	Transmit: 400mA		
(At maximum transmit power setting)	Receive: 250mA		
	Standby: 10mA		
Operating Temperature	-25° to 75°C (-13° to 167°F)		
Operating Humidity	10 to 90% (non-condensing)		



Feature	Description			
Storage Temperature	-40° to 80°C (-40° to 176°F)			
Storage Humidity	10% to 90%			
Maximum Electrostatic Discharge	4 kV			
Length	35mm (1.38 in.)			
Width	32mm (1.26 in.)			
Thickness	4.5mm (0.18 in.)			
Weight	9g (0.3 oz.)			
Mounting	60-pin connector 2 through hole (non-metallic screw recommended)			
Wireless Media	Direct Sequence-Spread Spectrum (DSSS) Orthogonal Frequency Divisional Multiplexing (OFDM)			
Media Access Protocol	Carrier sense multiple access with collision avoidance (CSMA/CA)			
Network Architecture Types	Infrastructure and ad hoc			
Network Standards	IEEE 802.11a, 802.11b, 802.11d, 802.11e, 802.11g, 802.11h, 802.11i			
Data Rates Supported	802.11a (OFDM) 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b (DSSS) 1, 2, 5.5, 11 Mbps 802.11g (OFDM) 6, 9, 12, 18, 24, 36, 48, 54 Mbps			
Modulation	BPSK @ 1, 6, and 9 Mbps QPSK @ 2, 12, and 18 Mbps CCK @ 5.5 and 11 Mbps 16-QAM @ 24 and 36 Mbps 64-QAM @ 48 and 54 Mbps			
Regulatory Domain Support	FCC (Americas, Parts of Asia, and Middle East) ETSI (Europe, Middle East, Africa, and Parts of Asia) MIC (formerly TELEC) (Japan) KCC (Korea)			
2.4 GHz Frequency Bands	ETSI 2.4 GHz to 2.483 GHz  FCC 2.4 GHz to 2.473 GHz  MIC 2.4 GHz to 2.495 GHz  KCC 2.4 GHz to 2.483 GHz			



Feature	Description
5 GHz Frequency Bands	ETSI 5.15 GHz to 5.35 GHz 5.47 GHz to 5.725 GHz
	FCC 5.15 GHz to 5.35 GHz 5.47 GHz to 5.725 GHz 5.725 GHz to 5.82 GHz
	MIC 5.15 GHz to 5.35 GHz
	KCC 5.15 GHz to 5.35 GHz 5.725 GHz to 5.82 GHz
2.4 GHz Operating Channels	ETSI: 13 (3 non-overlapping) FCC: 11 (3 non-overlapping) MIC: 14 (4 non-overlapping) KCC: 13 (3 non-overlapping)
5 GHz Operating Channels	ETSI: 19 non-overlapping FCC: 23 non-overlapping MIC: 8 non-overlapping KCC: 12 non-overlapping
Transmit Power Settings  Note: Maximum transmit power varies according to individual country regulations. All values nominal, +/-2 dBm	802.11a 15 dBm (30 mW) 10 dBm (10 mW) 0 dBm (1 mW)  802.11b 18 dBm (63 mW) 17 dBm (50 mW) 15 dBm (30 mW)
	10 dBm (10 mW) 0 dBm (1 mW)
	802.11g 15 dBm (30 mW) 10 dBm (10 mW) 0 dBm (1 mW)



Feature	Description			
Typical Receiver Sensitivity	802.11a:			
	6 Mbps	-85 dBm		
	9 Mbps	-82 dBm		
	12 Mbps	-79 dBm		
	18 Mbps 24 Mbps	-77 dBm -74 dBm		
	36 Mbps	-69 dBm		
	48 Mbps	-67 dBm		
	54 Mbps	-66 dBm (PER <= 10%)		
	802.11b:			
	1 Mbps	-96 dBm		
	2 Mbps	-93 dBm		
	5.5 Mbps	-92 dBm		
	11 Mbps	-90 dBm (PER <= 10%)		
	802.11g:			
	6 Mbps	-91 dBm		
	9 Mbps	-90 dBm		
	12 Mbps 18 Mbps	-88 dBm -86 dBm		
	24 Mbps	-83 dBm		
	36 Mbps	-78 dBm		
	48 Mbps	-75 dBm		
	54 Mbps	-73 dBm (PER <= 10%)		
Delay Spread	600 ns @ 1 Mbps			
	500 ns @ 2 Mb	pps		
	400 ns @ 5.5 N	Mbps		
	400 ns @ 6 Mb	pps		
	400 ns @ 9 Mb	pps		
	200 ns @ 11 N	1bps		
	350 ns @ 12 M	1bps		
	350 ns @ 18 M	1bps		
	250 ns @ 24 Mbps			
	250 ns @ 36 Mbps			
	150 ns @ 48 Mbps			
	150 ns @ 54 M	lbps		
Operating Systems Supported	Windows Mobil			
	Windows Mobil			
	Windows Mobil			
	Windows Mobil Windows Mobil			
		edded CE 6.0 R3		
		edded CE 6.0 R2		
	Windows Embe			
	Windows Embe			
	Windows XP P	rofessional and Embedded		



Feature	Description
Security	Standards  Wireless Equivalent Privacy (WEP)  Wi-Fi Protected Access (WPA)  IEEE 802.11i (WPA2)  Encryption  Wireless Equivalent Privacy (WEP, RC4 Algorithm)  Temporal Key Integrity Protocol (TKIP, RC4 Algorithm)  Advanced Encryption Standard (AES, Rijndael Algorithm)  Encryption Key Provisioning  Static (40-bit and 128-bit lengths)  Pre-Shared (PSK)  Dynamic  802.1X Extensible Authentication Protocol Types  EAP-FAST  EAP-TLS  PEAP-GTC  PEAP-MSCHAPv2
	■ LEAP
Note: For additional information, refer to the Certifications section of the Summit website: <a href="http://www.summitdatacom.com/certifications.htm">http://www.summitdatacom.com/certifications.htm</a>	ETSI Regulatory Domain  EN 300 328 EN 301 489-1 EN 301 489-17 EN 301 893 EN 60950-1 EU 2002/95/EC (RoHS)  FCC Regulatory Domain Part 15.247 Subpart C  Grant Test Report Part 15.407 Subpart E Grant Test Report DTS Test Report Industry Canada RSS-210 Grant Test Report



Feature	Description	
Certifications	Wi-Fi Alliance 802.11a, 802.11b, 802.11g WPA Enterprise WPA2 Enterprise Cisco Compatible Extensions (Version 4)	
	Globb Companies Extended (Volume 1)	
Warranty	Limited Lifetime	
All specifications are subject to change without notice		

## **Recommended Operating Conditions**

Parameter	Min.	Typical	Max.	Units	Comments
Supply Voltage					
■ VDDIO, VDDBUS ■ VDDCORE, PLLVDD, AVDD	3.0 1.71	3.3 1.8	3.6 1.89	V V	
Logic Inputs					
■ V <sub>INH</sub> , Input High Voltage ■ V <sub>INL</sub> , Input Low Voltage	2.0 _		- 0.8	V V	
Logic Outputs					
■ V <sub>OH</sub> , Output High Voltage ■ V <sub>OL</sub> , Output Low Voltage	2.4 -		_ 0.4	V V	Current is determined by the specific pad.

# **Pin Definitions**

Pin Number	Pin Name	I/O	Power Supply	Description
1	GND			Ground
2	Slot0_data3			Data bus, bit 3
3	Slot0_data4			Data bus, bit 4
4	Slot0_data5			Data bus, bit 5
5	Slot0_data6			Data bus, bit 6
6	Slot0_data7			Data bus, bit 7
7	Slot0_nCE1			Enable for even-numbered address bytes. Active low.
8	Slot0_addr10			Address bus, bit 10
9	Slot0_nOE			Memory access output enable. Active low.
10	Slot0_addr9			Address bus, bit 9
11	Slot0_addr8			Address bus, bit 8
12	Slot0_addr7			Address bus, bit 7
13	VCC3_3			3.3V Module Power
14	Slot0_addr6			Address bus, bit 6
15	Slot0_addr5			Address bus, bit 5
16	Slot0_addr4			Address bus, bit 4
17	Slot0_addr3			Address bus, bit 3
18	Slot0_addr2			Address bus, bit 2
19	Slot0_addr1			Address bus, bit 1
20	Slot0_addr0			Address bus, bit 0
21	Slot0_data0			Data bus, bit 0
22	Slot0_data1			Data bus, bit 1
23	Slot0_data2			Data bus, bit 2
24	Slot0_nlOIS16			Current access is 16 bit. Active low.
25	Slot0_nCD2			Card Detect. Tied to ground in module.
26		N/C		No Connect
27		N/C	_	No Connect



Pin Number	Pin Name	1/0	Power Supply	Description
28	WLAN_ACTIVE	0	VDDIO	Output to BT device. When high, indicates that WLAN is transmitting or receiving.  Do not connect when not used
29	VCC3_3			3.3V Module Power
30	GND			Ground
31	GND			Ground
32	Slot0_data10			Data bus, bit 10
33	Slot0_data9			Data bus, bit 9
34	Slot0_data8			Data bus, bit 8
35	Slot0_nSTSCHG			Module status change. Active low.  Status changed for PC Card I/O mode. This signal is asserted low to alert the host to changes in the READY and Write Protect states while the I/O interface is configured. Its use is controlled by the Card Config and Status Register.
				Note: MCF10AG pin 35 corresponds to the CF10G pin 46.
36	BT_ACTIVE	I	VDDIO	Input from BT device.  When high, indicates that Bluetooth is transmitting or receiving. The Summit radio does not transmit when BT_ACTIVE is high.  Tie to GND when not used
37	Slot0_nREG			Current access is to attribute memory. Active low.
38		N/C		No Connect
39	Slot0_nWAIT			Current access is extended. Active low.
40	Slot0_RESET			Card reset. Active high.
41	Slot0_nVS2			Not Used. Leave Open (Float)
42	WL_LED_ACT	0	VDDIO	WLAN LED activity indicator
43	INPACK			PC Card I/O mode input acknowledgment The signal is asserted by a CF storage card or CF+ card when the card is selected and responding to an I/O read cycle at the address on the address bus. The host uses the signal to control the enable of any input data buffers between the CF card and the CPU. The Summit radio driver uses memory mode



Pin Number	Pin Name	I/O	Power Supply	Description
				access, and Summit Engineering states that pin 43 is not defined or used when the driver uses memory mode access.
44	Slot0_nIREQ			Interrupt request. Active low.
45	Slot0_nWE			Memory access write enable. Active low.
46	Slot0_nIOW			IO access write enable. Active low.
47	Slot0_nIOR			IO access read enable. Active low.
48	Slot0_nVS1			Voltage Sense. Tied to GND in module.
49	Slot0_nCE2			Enable for even-numbered address bytes.  The fact that the signal on pin 49 stays "high" is normal behavior because the Summit driver uses memory mode access. It does not behave like a PIO card.
50	Slot0_data15			Data bus, bit 15
51	Slot0_data14			Data bus, bit 14
52	Slot0_data13			Data bus, bit 13
53	Slot0_data12			Data bus, bit 12
54	Slot0_data11			Data bus, bit 11
55		N/C		No Connect
56		N/C		No Connect
57		N/C		No Connect
58		N/C		No Connect
59		N/C		No Connect
60	GND			Ground

**Note:** Although the Broadcom 4318E chip is capable of using memory mode or I/O access, the Summit driver uses memory mode only and does not support I/O mode access to the CF interface.

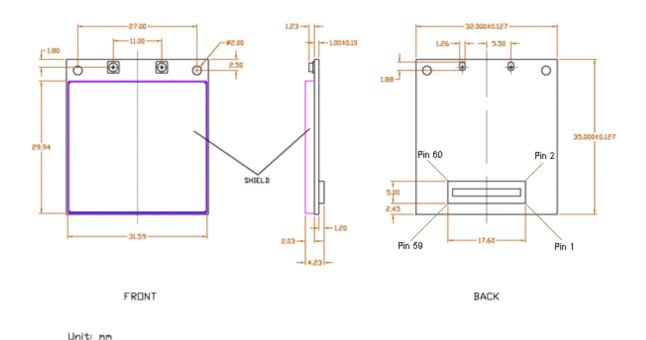


## **Mechanical Specifications**

#### **Connector Overview**

MCF10AG/MSD10AG connector: Molex 54722-0607 60-pin connector

Mating connector (on board): Molex 55560-0607 60-pin connector



## **Mounting**

Through-hole mounting with a 60-pin connector.

## **RF** Layout Design Guidelines

The following is a list of RF layout design guidelines and recommendation when installing a Summit radio into your device.

- Do not run antenna cables directly above or directly below the radio.
- Do not place any parts or run any high speed digital lines below the radio.
- If there are other radios or transmitters located on the device (such as a Bluetooth radio), place the devices as far apart from each other as possible.
- Ensure that there is the maximum allowable spacing separating the antenna connectors on the Summit radio from the antenna. In addition, do not place antennas directly above or directly below the radio.
- Summit recommends the use of a double shielded cable for the connection between the radio and the antenna elements.



Summit has provided three plated mounting holes that can be used for grounding. When additional
ground plane is required, you may use some or all of these grounded mounting holes.

## Regulatory

#### **Certified Antennas**

The SDC-MCF10AG provides two Hirose U.FL type antenna connectors to support transmit and receive diversity. For single antenna, non-diversity applications, OEMs are advised to use the Main (not Aux) antenna connector and should disable transmit and receive diversity from the Global tab of the Summit Client Utility (SCU) software utility.

The SDC-MCF10AG has been tested to the regulatory standards defined in the "Certifications" section of the Specifications table above. These tests were conducted with the following antennas:

Laird NanoBlade (click for datasheet)

Form Factor: PCB

Type: Dipole

Maximum 2.4 GHz Gain: 3.8 dBi
 Maximum 5 GHz Gain: 5.1 dBi

#### Radiall Larson Dipole (click for datasheet)

• Form Factor: Whip

Type: Dipole

Maximum 2.4 GHz Gain: 1.6 dBi
 Maximum 5 GHz Gain: 5 dBi

Antennas of differing types and higher gains may be integrated as well. If necessary, with the Summit Manufacturing Utility software utility, OEMs may reduce the transmit power of the SDC-MCF10AG to account for higher antenna gain. In some cases, OEMs may be able to reduce certification efforts by using antennas that are of like type and equal or lesser gain to the above listed antennas.

## **Documentation Requirements**

In order to maintain regulatory compliance, when integrating the SDC-MCF10AG into a host device and leveraging Summit's grants and certifications, it is necessary to meet the documentation requirements set forth by the applicable regulatory agencies. The following sections (FCC, Industry Canada, and European Union) outline the information that must be included in the user's guide and external labels for the host devices into which the SDC-MCF10AG is integrated.



#### **FCC**

#### **User's Guide Requirements**

As outlined in the Operational Description, the SDC-MCF10AG complies with <u>FCC Part 15 Rules</u> for a Limited Modular Approval. To leverage Summit's grant, the two conditions below must be met for the host device into which the SDC-MCF10AG is integrated:

- 1. The antenna is installed with 20 cm maintained between the antenna and users.
- 2. The transmitter module is not co-located with any other transmitter or antenna that is capable of simultaneous operation.

As long as the two conditions above are met, further *transmitter* testing is typically not required. However, the OEM integrator is still responsible for testing its end-product for any additional compliance requirements required with this module installed, such as (but not limited to) digital device emissions and PC peripheral requirements.

## IMPORTANT!

In the event that the two conditions above *cannot be met* (for example certain device configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID *cannot* be used on the final product. In these circumstances, the OEM integrator will be responsible for reevaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

When using Summit's FCC grant for the SDC-MCF10AG, the integrator must include specific information in the user's guide for the device into which the SDC-MCF10AG is integrated. The integrator must not provide information to the end user regarding how to install or remove this RF module in the user's manual of the device into which the SDC-MCF10AG is integrated. The following FCC statements must be added in their entirety and without modification into a prominent place in the user's guide for the device into which the SDC-MCF10AG is integrated:

"IMPORTANT NOTE: To comply with FCC RF exposure compliance requirements, the antenna used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter."

#### **Federal Communication Commission Interference Statement**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or



television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- 1. Reorient or relocate the receiving antenna.
- 2. Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- 4. Consult the dealer or an experienced radio/TV technician for help.

**FCC Caution:** Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

#### **IMPORTANT NOTE:** FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

#### **Labeling Requirements**

The final end product must be labeled in a visible area with the following notice:

Contains FCC ID: TWG-SDCMCF10AG

#### **Industry Canada**

#### **User's Guide Requirements**

As outlined in the Operational Description, the SDC-MCF10AG complies with Industry Canada (IC) rules for a Limited Modular Approval. To leverage Summit's grant, the two conditions below must be met for the host device into which the SDC-MCF10AG is integrated:

- 1. The antenna is installed with 20 cm maintained between the antenna and users.
- 2. The transmitter module is not co-located with any other transmitter or antenna that is capable of simultaneous operation.

As long as the two conditions above are met, further *transmitter* testing is typically not required. However, the OEM integrator is still responsible for testing its end-product for any additional



compliance requirements required with this module installed, such as (but not limited to) digital device emissions and PC peripheral requirements.

## IMPORTANT!

In the event that the two conditions above *cannot be met* (for example certain device configurations or co-location with another transmitter), then the IC authorization is no longer considered valid and the IC ID *cannot* be used on the final product. In these circumstances, the OEM integrator will be responsible for reevaluating the end product (including the transmitter) and obtaining a separate IC authorization.

When using Summit's IC grant for the SDC-MCF10AG, the integrator must include specific information in the user's guide for the device into which the SDC-MCF10AG is integrated. The integrator must not provide information to the end user regarding how to install or remove this RF module in the user's manual of the device into which the SDC-MCF10AG is integrated. In addition to the required FCC statements outlined above, the following IC statements must be added in their entirety and without modification into a prominent place in the user's guide for the device into which the SDC-MCF10AG is integrated:

To prevent radio interference to the licensed service, this device is intended to be operated indoors and away from windows to provide maximum shielding. Equipment (or its transmit antenna) that is installed outdoors is subject to licensing.

The integrator must list out information for each antenna used with the host device into which the SDC-MCF10AG is integrated. The following examples are based on antennas with which the SDC-MCF10AG was certified and represent an acceptable format:

#### **Laird NanoBlade**

Form Factor: PCB

Type: Dipole

Maximum 2.4 GHz Gain: 3.8 dBi
 Maximum 5 GHz Gain: 5.1 dBi

#### **Radiall Larson Dipole**

Form Factor: Whip

Type: Dipole

Maximum 2.4 GHz Gain: 1.6 dBi
 Maximum 5 GHz Gain: 5 dBi

#### **Labeling Requirements**

The final end product must be labeled in a visible area with the following notice:

Contains IC ID: 6616A-SDCMCF10AG



### European Union

#### **User's Guide Requirements**

The integrator must include specific information in the user's guide for the device into which the SDC-MCF10AG is integrated. In addition to the required FCC and IC statements outlined above, the following R&TTE statements must be added in their entirety and without modification into a prominent place in the user's guide for the device into which the SDC-MCF10AG is integrated:

This device complies with the essential requirements of the R&TTE Directive 1999/5/EC. The following test methods have been applied in order to prove presumption of conformity with the essential requirements of the R&TTE Directive 1999/5/EC:

#### EN60950-1:2001 A11:2004

Safety of Information Technology Equipment

#### EN 300 328 V1.7.1: (2006-10)

Electromagnetic compatibility and Radio spectrum Matters (ERM); Wideband Transmission systems; Data transmission equipment operating in the 2,4 GHz ISM band and using spread spectrum modulation techniques; Harmonized EN covering essential requirements under article 3.2 of the R&TTE Directive

#### EN 301 489-1 V1.6.1: (2005-09)

Electromagnetic compatibility and Radio Spectrum Matters (ERM); ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 1: Common technical requirements

#### EN 301 489-17 V1.2.1 (2002-08)

Electromagnetic compatibility and Radio spectrum Matters (ERM); ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 17: Specific conditions for 2,4 GHz wideband transmission systems and 5 GHz high performance RLAN equipment

#### EN 301 893

Electromagnetic compatibility and Radio spectrum Matters (ERM); Broadband Radio Access Networks (BRAN); Specific conditions for 5 GHz high performance RLAN equipment

#### EU 2002/95/EC (RoHS)

Declaration of Compliance – EU Directive 2003/95/EC; Reduction of Hazardous Substances (RoHS)

This device is a 2.4 GHz wideband transmission system (transceiver), intended for use in all EU member states and EFTA countries, except in France and Italy where restrictive use applies.

In Italy the end-user should apply for a license at the national spectrum authorities in order to obtain authorization to use the device for setting up outdoor radio links and/or for supplying public access to telecommunications and/or network services.

This device may not be used for setting up outdoor radio links in France and in some areas the RF output power may be limited to 10 mW EIRP in the frequency range of 2454 – 2483.5 MHz. For detailed information the end-user should contact the national spectrum authority in France.



েটČesky [Czech]	[Jméno výrobce] tímto prohlašuje, že tento [typ zařízení] je ve shodě se základními požadavky a dalšími příslušnými ustanoveními směrnice 1999/5/ES.
daDansk [Danish]	Undertegnede [fabrikantens navn] erklærer herved, at følgende udstyr [udstyrets typebetegnelse] overholder de væsentlige krav og øvrige relevante krav i direktiv 1999/5/EF.
de Deutsch [German]	Hiermit erklärt [Name des Herstellers], dass sich das Gerät [Gerätetyp] in Übereinstimmung mit den grundlegenden Anforderungen und den übrigen einschlägigen Bestimmungen der Richtlinie 1999/5/EG befindet.
et Eesti [Estonian]	Käesolevaga kinnitab [tootja nimi = name of manufacturer] seadme [seadme tüüp = type of equipment] vastavust direktiivi 1999/5/EÜ põhinõuetele ja nimetatud direktiivist tulenevatele teistele asjakohastele sätetele.
en English	Hereby, [name of manufacturer], declares that this [type of equipment] is in compliance with the essential requirements and other relevant provisions of Directive 1999/5/EC.
≅Español [Spanish]	Por medio de la presente [nombre del fabricante] declara que el [clase de equipo] cumple con los requisitos esenciales y cualesquiera otras disposiciones aplicables o exigibles de la Directiva 1999/5/CE.
elΕλληνική [Greek]	ΜΕ ΤΗΝ ΠΑΡΟΥΣΑ [name of manufacturer] ΔΗΛΩΝΕΙ ΟΤΙ [type of equipment] ΣΥΜΜΟΡΦΩΝΕΤΑΙ ΠΡΟΣ ΤΙΣ ΟΥΣΙΩΔΕΙΣ ΑΠΑΙΤΗΣΕΙΣ ΚΑΙ ΤΙΣ ΛΟΙΠΕΣ ΣΧΕΤΙΚΕΣ ΔΙΑΤΑΞΕΙΣ ΤΗΣ ΟΔΗΓΙΑΣ 1999/5/ΕΚ.
français [French]	Par la présente [nom du fabricant] déclare que l'appareil [type d'appareil] est conforme aux exigences essentielles et aux autres dispositions pertinentes de la directive 1999/5/CE.
it Italiano [Italian]	Con la presente [nome del costruttore] dichiara che questo [tipo di apparecchio] è conforme ai requisiti essenziali ed alle altre disposizioni pertinenti stabilite dalla direttiva 1999/5/CE.
Latviski [Latvian]	Ar šo [name of manufacturer / izgatavotāja nosaukums] deklarē, ka [type of equipment / iekārtas tips] atbilst Direktīvas 1999/5/EK būtiskajām prasībām un citiem ar to saistītajiem noteikumiem.
Lietuvių [Lithuanian]	Šiuo [manufacturer name] deklaruoja, kad šis [equipment type] atitinka esminius reikalavimus ir kitas 1999/5/EB Direktyvos nuostatas.
nl Nederlands [Dutch]	Hierbij verklaart [naam van de fabrikant] dat het toestel [type van toestel] in overeenstemming is met de essentiële eisen en de andere relevante bepalingen van richtlijn 1999/5/EG.
mt Malti [Maltese]	Hawnhekk, <i>[isem tal-manifattur]</i> , jiddikjara li dan <i>[il-mudel tal-prodott]</i> jikkonforma mal-ħtiġijiet essenzjali u ma provvedimenti oħrajn relevanti li hemm fid-Dirrettiva 1999/5/EC.



իսMagyar [Hungarian]	Alulírott, [gyártó neve] nyilatkozom, hogy a [ típus] megfelel a vonatkozó alapvető követelményeknek és az 1999/5/EC irányelv egyéb előírásainak.
Polski [Polish]	Niniejszym [nazwa producenta] oświadcza, że [nazwa wyrobu] jest zgodny z zasadniczymi wymogami oraz pozostałymi stosownymi postanowieniami Dyrektywy 1999/5/EC.
Português [Portuguese]	[Nome do fabricante] declara que este [tipo de equipamento] está conforme com os requisitos essenciais e outras disposições da Directiva 1999/5/CE.
ুৱা Slovensko [Slovenian]	[Ime proizvajalca] izjavlja, da je ta [tip opreme] v skladu z bistvenimi zahtevami in ostalimi relevantnimi določili direktive 1999/5/ES.
Slovensky [Slovak]	[Meno výrobcu] týmto vyhlasuje, že [typ zariadenia] spĺňa základné požiadavky a všetky príslušné ustanovenia Smernice 1999/5/ES.
fi Suomi [Finnish]	[Valmistaja = manufacturer] vakuuttaa täten että [type of equipment = laitteen tyyppimerkintä] tyyppinen laite on direktiivin 1999/5/EY oleellisten vaatimusten ja sitä koskevien direktiivin muiden ehtojen mukainen.
Svenska [Swedish]	Härmed intygar [företag] att denna [utrustningstyp] står I överensstämmelse med de väsentliga egenskapskrav och övriga relevanta bestämmelser som framgår av direktiv 1999/5/EG.

## **Labeling Requirements**

The final end product must be labeled in a visible area with the following notice:

